

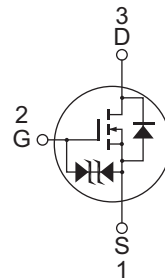
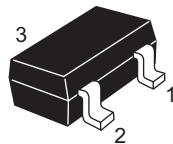
RQK0606KGDQA

Features

- Low on-resistance
 $R_{DS(on)} = 173 \text{ m}\Omega$ typ.(at $V_{GS} = 4.5 \text{ V}$, $I_D = 0.8 \text{ A}$)
- Low drive current
- High speed switching
- $V_{DSS} \geq 60 \text{ V}$ and capable of 2.5 V gate drive

Outline

(Package name: MPAK)



1. Source
2. Gate
3. Drain

Notes: Marking is "KG".

Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	± 12	V
Drain current	I_D	1.5	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	6	A
Body - drain diode reverse drain current	I_{DR}	1.5	A
Channel dissipation	P_{ch} ^{Note2}	0.8	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10 \mu\text{s}$, Duty cycle $\leq 1\%$

2. When using the glass epoxy board (FR-4 40 × 40 × 1 mm)

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Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	+12	—	—	V	$I_G = +100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	-12	—	—	V	$I_G = -100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	+10	μA	$V_{GS} = +10 \text{ V}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	-10	μA	$V_{GS} = -10 \text{ V}$, $V_{DS} = 0$
Drain to source leak current	I_{DSS}	—	—	1	μA	$V_{DS} = 60 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Drain to source on state resistance	$R_{DS(on)}$	—	173	225	$\text{m}\Omega$	$I_D = 0.8 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note3}
Drain to source on state resistance	$R_{DS(on)}$	—	207	290	$\text{m}\Omega$	$I_D = 0.8 \text{ A}$, $V_{GS} = 2.5 \text{ V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	2.3	4	—	S	$I_D = 0.8 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note3}
Input capacitance	C_{iss}	—	200	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	25	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	14	—	pF	$f = 1 \text{ MHz}$
Turn - on delay time	$t_{d(on)}$	—	11	—	ns	$I_D = 0.8 \text{ A}$
Rise time	t_r	—	27	—	ns	$V_{GS} = 10 \text{ V}$
Turn - off delay time	$t_{d(off)}$	—	31	—	ns	$R_L = 12.5 \text{ }\Omega$
Fall time	t_f	—	4	—	ns	$R_g = 4.7 \text{ }\Omega$
Total gate charge	Q_g	—	2.2	—	nC	$V_{DD} = 10 \text{ V}$
Gate to Source charge	Q_{gs}	—	0.4	—	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Q_{gd}	—	0.7	—	nC	$I_D = 1.5 \text{ A}$
Body - drain diode forward voltage	V_{DF}	—	0.8	—	V	$I_F = 1.5 \text{ A}$, $V_{GS} = 0$ ^{Note3}

Notes: 3. Pulse test